

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Naoshi ADACHI

Serial No.: to be assigned

Filed: January 5, 2004

For: HEAT TREATMENT JIG FOR SEMICONDUCTOR SUBSTRATE AND  
METHOD OF HEAT TREATING SEMICONDUCTOR FOR SUBSTRATE

**INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

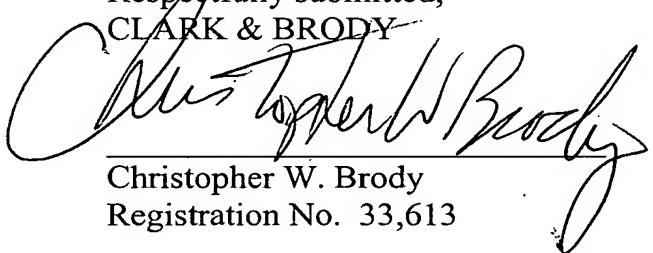
Sir:

In accordance with the provisions of 37 C.F.R. 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the references listed on the attached form PTO-1449. It is respectfully requested that the references be expressly considered during the prosecution of this application, and that the references be made of record therein and appear among the "References Cited" on any patent to issue therefrom.

Applicants respectfully submit that this disclosure is being made with the filing of the application, hence, no fee is required.

Respectfully submitted,

CLARK & BRODY

  
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Docket No.: 12054-0023  
Date: January 5, 2004

FORM PTO-1449

INFORMATION DISCLOSURE  
CITATION

Attorney Docket: 12054-0023

Serial No.: to be assigned

Applicant: Naohsi ADACHI et al.

Filing Date: January 5, 2004

Group:

## U.S. PATENT DOCUMENTS

Examiner Initial		Document Number	Date	Name	Class	Sub-Class	Filing Date

## FOREIGN PATENT DOCUMENTS

Examiner Initial		Document Number	Date	Country	Class	Sub-Class	Translation Yes	No
		2001-358086	12/26/2001	Japan			x	
		2003-037112	02/07/2003	Japan			x	
		09-199438	07/31/1997	Japan			x	
		10-270369	10/09/1998	Japan			x	

## OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, etc.)


Examiner:

Date Considered:

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.